

Standard SCRs, 16A

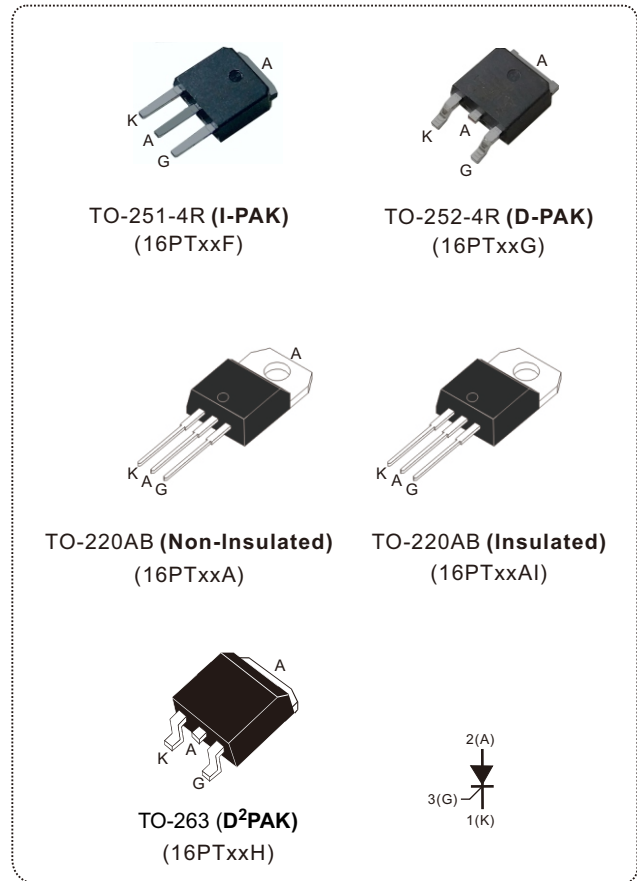
Main Features

Symbol	Value	Unit
$I_{T(RMS)}$	16	A
V_{DRM}/V_{RRM}	600 to 1000	V
I_{GT}	25	mA

DESCRIPTION

The 16PT series of silicon controlled rectifiers are high performance glass passivated technology, and are suitable for general purpose applications.

Using clip assembly technology, they provide a superior performance in surge current capabilities.



ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS		VALUE	UNIT
RMS on-state current full sine wave (180° conduction angle)	$I_{T(RMS)}$	TO-251-4R/TO-252-4R TO-220AB/TO-263	$T_c = 110^\circ\text{C}$	16	A
		TO-220AB insulated	$T_c = 86^\circ\text{C}$		
Average on-state current (180° conduction angle)	$I_{T(AV)}$	TO-251-4R/TO-252-4R TO-220AB/TO-263	$T_c = 110^\circ\text{C}$	10	A
		TO-220AB insulated	$T_c = 86^\circ\text{C}$		
Non repetitive surge peak on-state current (full cycle, T_j initial = 25°C)	I_{TSM}	F = 50 Hz	t = 20 ms	190	A
		F = 60 Hz	t = 16.7 ms	200	
I ² t Value for fusing	I ² t	$t_p = 10$ ms		180	A ² s
Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \leq 100$ ns	di/dt	F = 60 Hz	$T_j = 125^\circ\text{C}$	50	A/ μ s
Peak gate current	I_{GM}	$T_p = 20$ μ s	$T_j = 125^\circ\text{C}$	4	A
Maximum gate power	P_{GM}	$T_p = 20$ μ s	$T_j = 125^\circ\text{C}$	10	W
Average gate power dissipation	$P_{G(AV)}$	$T_j = 125^\circ\text{C}$		1	W
Repetitive peak off-state voltage	V_{DRM}	$T_j = 125^\circ\text{C}$		600 to 1000	V
Repetitive peak reverse voltage	V_{RRM}				
Storage temperature range	T_{stg}			- 40 to + 150	°C
Operating junction temperature range	T_j			- 40 to + 125	

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
SYMBOL	TEST CONDITIONS		16PTxxxx		Unit	
			D	-		
I _{GT}	V _D = 12V, R _L = 33Ω	Min.	4	2	mA	
		Max.	10	25		
V _{GT}		Max.	1.3	1.3	V	
V _{GD}	V _D = V _{DRM} , R _L = 3.3KΩ R _{GK} = 220Ω	T _J = 125°C	Min.	0.2	0.2	V
I _H	I _T = 500mA, Gate open		Max.	10	40	mA
I _L	I _G = 1.2×I _{GT}		Max.	20	60	mA
dV/dt	V _D = 67% V _{DRM} , Gate open	T _J = 125°C	Min.	100	500	V/μs
V _{TM}	I _T = 32A, t _p = 380μs	T _J = 25°C	Max.	1.6		V
I _{DRM} I _{RRM}	V _D = V _{DRM} , V _R = V _{RRM}	T _J = 25°C	Max.	5		μA
	R _{GK} = 220Ω	T _J = 125°C	Max.	2		mA
V _{to}	Threshold Voltage	T _J = 125°C	Max.	0.77		V
R _d	Dynamic Resistance	T _J = 125°C	Max.	23		mΩ

DYNAMIC CHARACTERISTICS						
SYMBOL	PARAMETER	TEST CONDITIONS	VALUE			UNIT
			Min.	Typ.	Max.	
t _{gt}	Gate-controlled turn-on time	I _{TM} = 40A, V _D = V _{DRM} (Max.), I _G = 0.1A, dI _G /dt = 5A/μs, T _J = 25°C	-	2.0	-	μS
t _q	Commutated turn-off time	V _D = 67% V _{DRM} , I _{TM} = 30A, V _R = 25V, R _{GK} = 100Ω, dI _{TM} /dt = 30A/μs, dV _D /dt = 50V/μs, T _J = 125°C	-	70	-	μS

THERMAL RESISTANCE				
SYMBOL	Parameter		VALUE	UNIT
R _{th(j-c)}	Junction to case (DC)		IPAK/DPAK/TO-220AB/TO-263	1.1 °C/W
R _{th(j-a)}	Junction to ambient	S = 1 cm ²	TO-263(D ² PAK)	45
		S = 0.5 cm ²	TO-252(D-PAK)	70
			TO-220AB	60
			TO-251-4R(I-PAK)	100

S=Copper surface under tab

PRODUCT SELECTOR					
PART NUMBER	VOLTAGE (xx)			SENSITIVITY	PACKAGE
	600 V	800 V	1000 V		
16PTxxA/16PTxxAI	V	V	V	25 mA	TO-220AB
16PTxxF	V	V	V	25 mA	I-PAK
16PTxxG	V	V	V	25 mA	D-PAK
16PTxxH	V	V	V	25 mA	D ² PAK
16PTxxA-D/16PTxxAI-D	V	V	V	4-10 mA	TO-220AB
16PTxxF-D	V	V	V	4-10 mA	I-PAK
16PTxxG-D	V	V	V	4-10 mA	D-PAK
16PTxxH-D	V	V	V	4-10 mA	D ² PAK

ORDERING INFORMATION					
ORDERING TYPE	MARKING	PACKAGE	WEIGHT	BASE Q'TY	DELIVERY MODE
16PTxxA/16PTxxA-D	16PTxxA/16PTxxA-D	TO-220AB	2.0g	50	Tube
16PTxxAI/16PTxxAI-D	16PTxxAI/16PTxxAI-D	TO-220AB (insulated)	2.3g	50	Tube
16PTxxF/16PTxxF-D	16PTxxF/16PTxxF-D	TO-251-4R(I-PAK)	0.40g	80	Tube
16PTxxG/16PTxxG-D	16PTxxG/16PTxxG-D	TO-252-4R(D-PAK)	0.38g	80	Tube
16PTxxH/16PTxxH-D	16PTxxH/16PTxxH-D	TO-263(D ² PAK)	2.0g	50	Tube

Note: xx = voltage

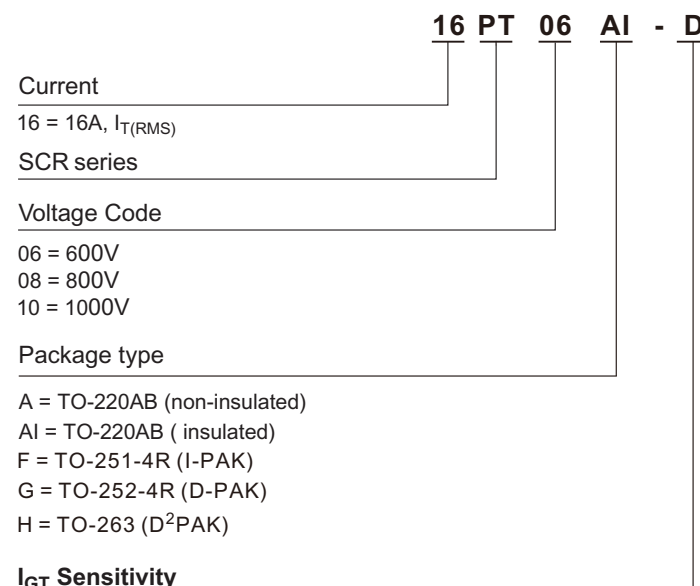
ORDERING INFORMATION SCHEME	
<p>Current 16 = 16A, $I_{T(RMS)}$</p> <p>SCR series</p> <p>Voltage Code 06 = 600V 08 = 800V 10 = 1000V</p> <p>Package type A = TO-220AB (non-insulated) AI = TO-220AB (insulated) F = TO-251-4R (I-PAK) G = TO-252-4R (D-PAK) H = TO-263 (D²PAK)</p> <p>I_{GT} Sensitivity D = 4~10 mA Blank = 3~25mA</p>	<p>16 PT 06 AI - D</p> 

Fig.1 Maximum average power dissipation versus average on-state current.

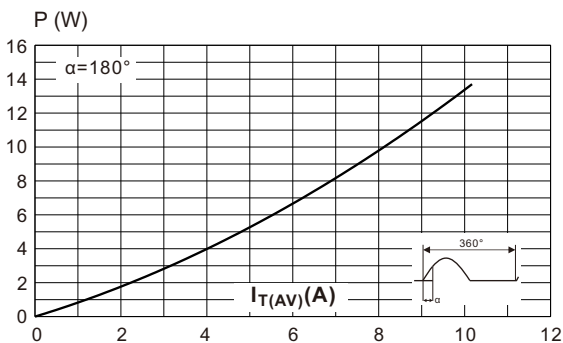


Fig.2 Average and D.C. on-state current versus case temperature.

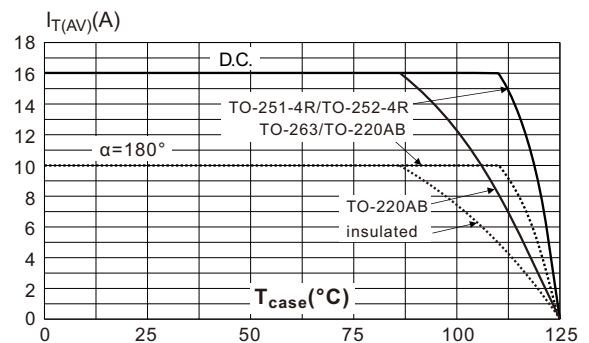


Fig.3 Average and D.C. on-state current versus ambient temperature. (copper surface under tab: S=1cm²) (D²PAK)

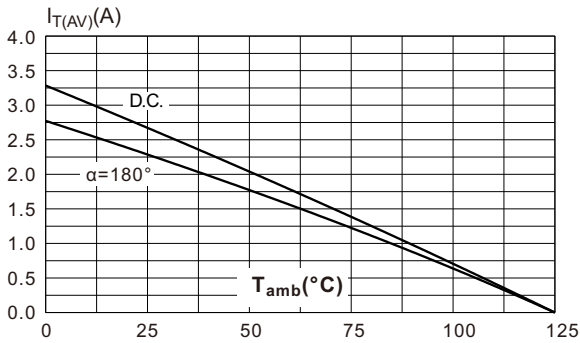


Fig.4 Relative variation of thermal impedance versus pulse duration.

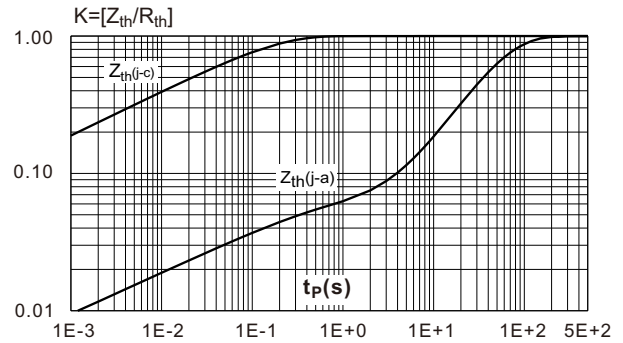


Fig.5 Relative variation of gate trigger current, holding current and latching current and latching current versus junction temperature.

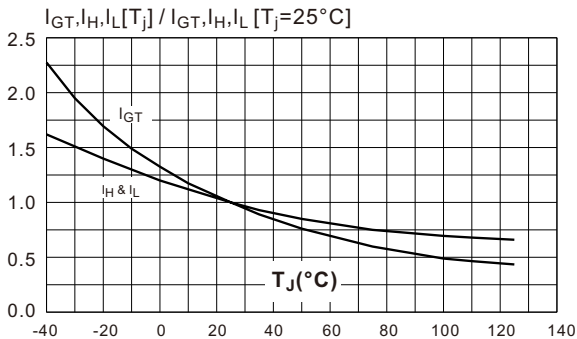


Fig.6 Surge peak on-state current versus number of cycles.

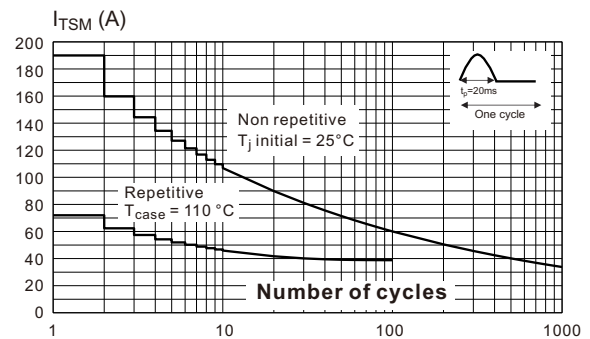


Fig.7 Non-repetitive surge peak on-state current for a sinusoidal pulse with width t_p < 10 ms, and corresponding values of I²t

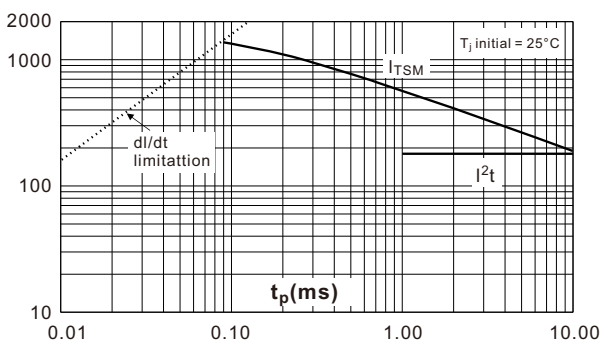


Fig.8 On-state characteristics (maximum values)

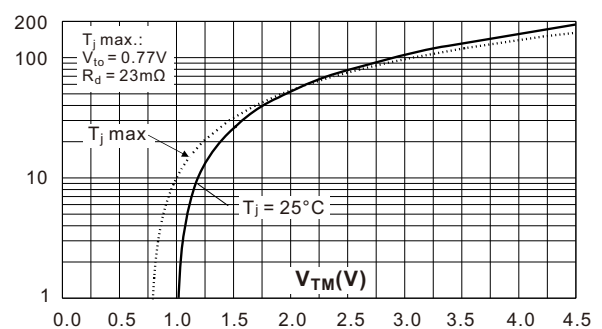
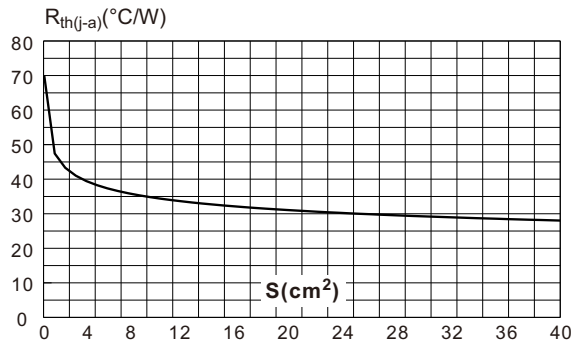
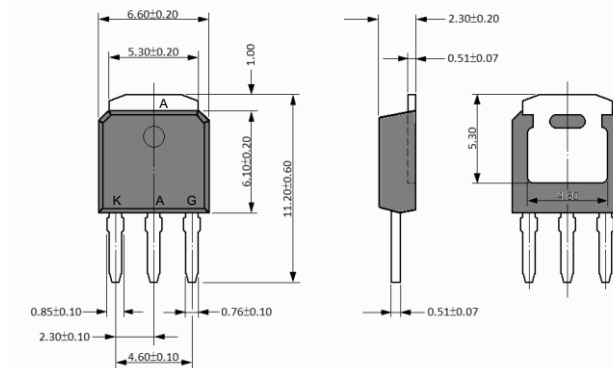


Fig.9 Thermal resistance junction to ambient versus copper surface under tab (epoxy printed circuit board Fr4, copper thickness: 35 μm)(D²PAK)

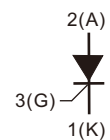
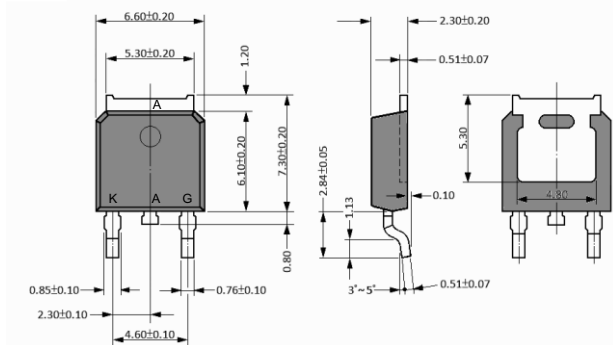


Case Style

TO-251-4R (I-PAK)



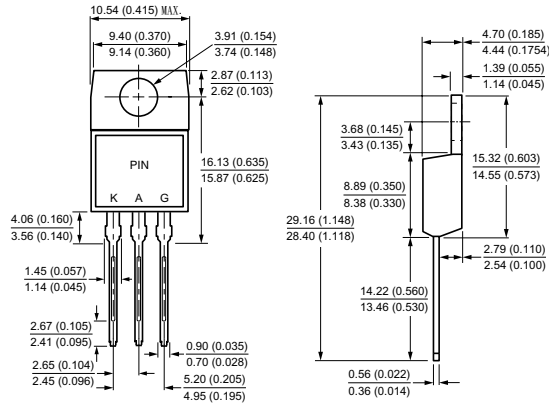
TO-252-4R (D-PAK)



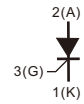
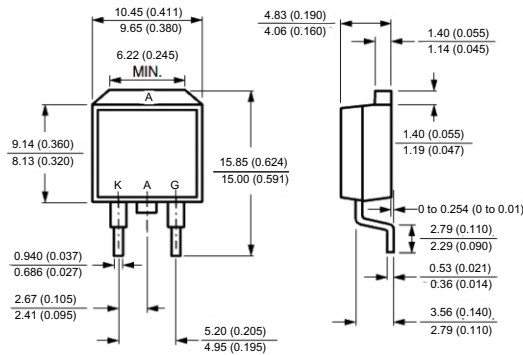
All dimensions in millimeters(inches)

Case Style

TO-220AB



TO-263(D²PAK)



All dimensions in millimeters(inches)